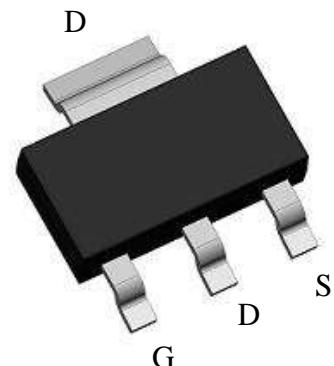


N-Channel Enhancement Mode Power MOSFET

Description :

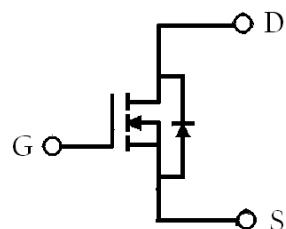
The KLEA2N15 is a N-channel enhancement-mode MOSFET, providing the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost effectiveness. The SOT-223 package is universally preferred for all commercial-industrial surface mount applications.

SOT-223



Features:

- Single Drive Requirement
- Fast Switching Characteristic
- Repetitive Avalanche Rated
- Pb-free lead plating and halogen-free package



G : Gate D : Drain S : Source

BVDSS	150V
ID@VGS=10V, TA=25°C	3A
RDS(on)@VGS=10V, ID=2.8A	119mΩ(typ)

Ordering Information

Device	Package	Shipping
KLEA2N15	SOT-223 (Pb-free lead plating and halogen-free package)	2500 pcs / tape & reel

Absolute Maximum Ratings ($T_a=25^\circ C$)

Parameter	Symbol	Limits	Unit
Drain-Source Voltage	V_{DS}	150	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current @ $V_{GS}=10V$, $T_c=25^\circ C$	I_D	5.2	A
Continuous Drain Current @ $V_{GS}=10V$, $T_c=100^\circ C$		3.3	
Continuous Drain Current @ $V_{GS}=10V$, $T_a=25^\circ C$		3	
Continuous Drain Current @ $V_{GS}=10V$, $T_a=70^\circ C$		2.4	
Pulsed Drain Current	I_{DM}	16 *1	
Total Power Dissipation	P_D	8.3	W
		3.3	
		2.8	
		1.1	
Operating Junction and Storage Temperature Range	T_j, T_{stg}	-55~+150	°C

Thermal Data

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-case, max	$R_{th,j-c}$	15	°C/W
Thermal Resistance, Junction-to-ambient, max	$R_{th,j-a}$	45 *3	

- Note : 1. Pulse width limited by maximum junction temperature
 2. Duty cycle $\leq 1\%$
 3. Surface mounted on 1 in² copper pad of FR-4 board, 120°C/W when mounted on minimum copper pad

Characteristics ($T_c=25^\circ C$, unless otherwise specified)

Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Static					
BV_{DSS}	150	-	-	V	$V_{GS}=0V, I_D=250\mu A$
$V_{GS(th)}$	2.0	-	4.0		$V_{DS} = V_{GS}, I_D=250\mu A$
$G_{FS} *1$	-	4.5	-	S	$V_{DS} = 10V, I_D=1.6A$
I_{GSS}	-	-	± 100	nA	$V_{GS}=\pm 20V, V_{DS}=0V$
I_{DSS}	-	-	1	μA	$V_{DS} = 120V, V_{GS}=0V$
	-	-	25		$V_{DS} = 120V, V_{GS} = 0V, T_j=125^\circ C$
$R_{DS(ON)} *1$	-	119	160	mΩ	$V_{GS} = 10V, I_D=2.8A$
Dynamic					
C_{iss}	-	536	-	pF	$V_{GS}=0V, V_{DS}=25V, f=1MHz$
C_{oss}	-	57	-		
C_{rss}	-	21	-		

Characteristics (T_c=25°C, unless otherwise specified)

Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Q _g *1, 2	-	12	-	nC	V _{DS} =75V, V _{GS} =10V, I _D =3A
Q _{gs} *1, 2	-	2.2	-		
Q _{gd} *1, 2	-	4.9	-		
t _{d(ON)} *1, 2	-	6	-	ns	V _{DS} =25V, I _D =1A, V _{GS} =10V, R _{GS} =6Ω
t _r *1, 2	-	12	-		
t _{d(OFF)} *1, 2	-	17	-		
t _f *1, 2	-	4	-		

Source-Drain Diode

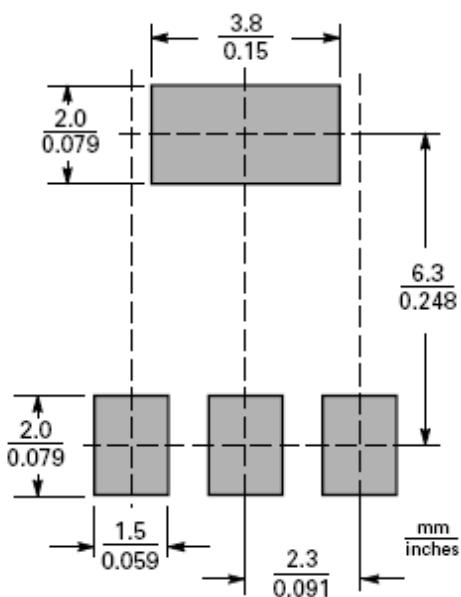
I _S *1	-	-	2.1	A	
I _{SM} *3	-	-	8.4		
V _{SD} *1	-	0.76	1.3	V	I _F =I _S , V _{GS} =0V
t _{rr}	-	40	-	ns	I _F =I _S , dI _F /dt=100A/μs
Q _{rr}	-	100	-		

Note : *1.Pulse Test : Pulse Width ≤300μs, Duty Cycle≤2%

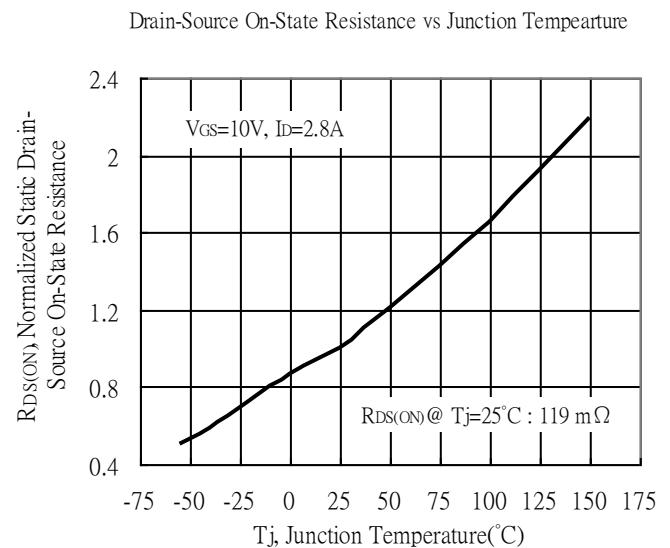
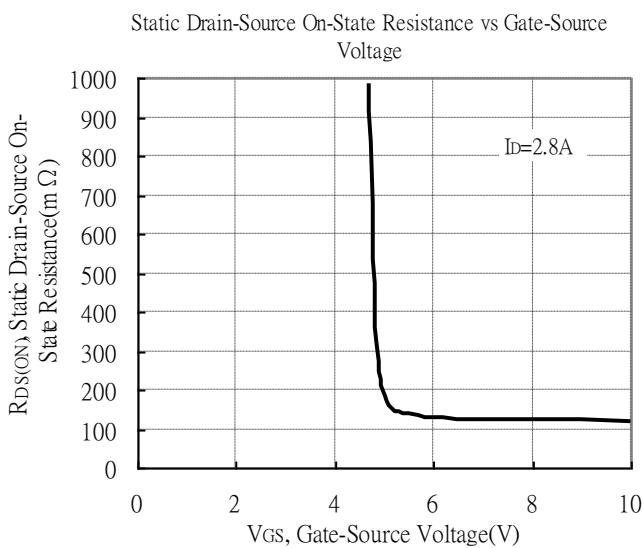
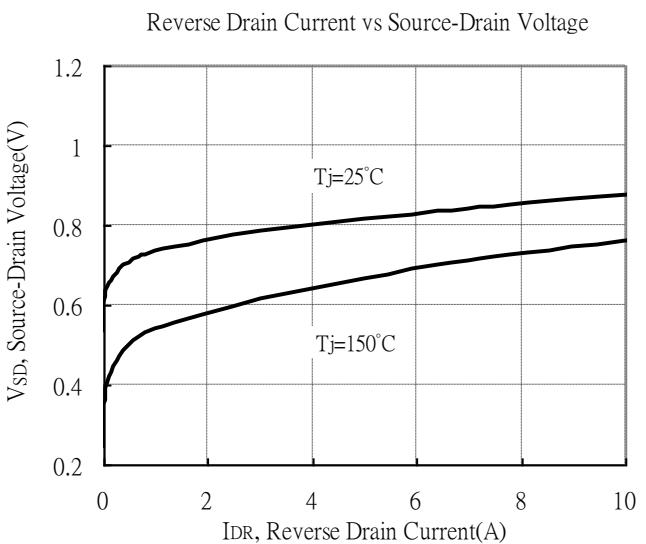
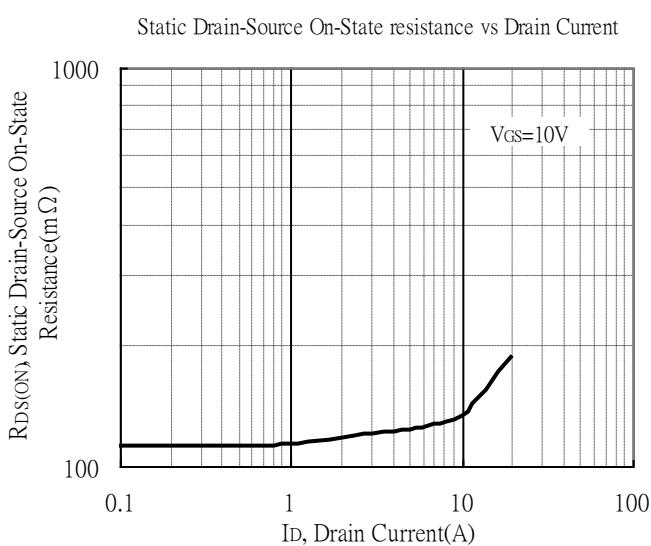
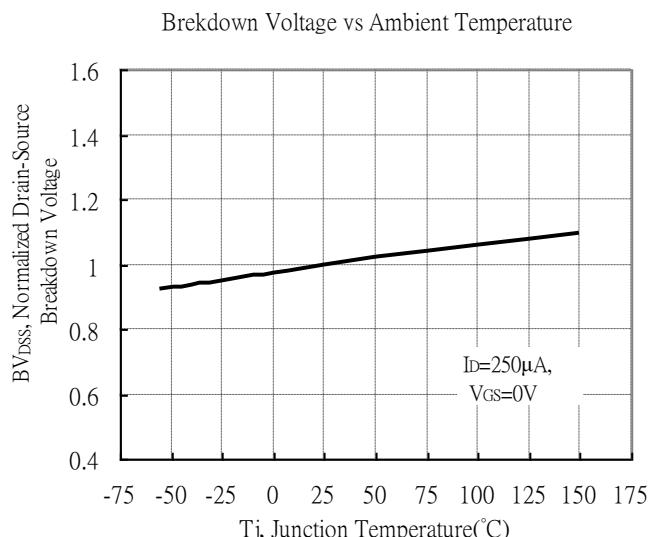
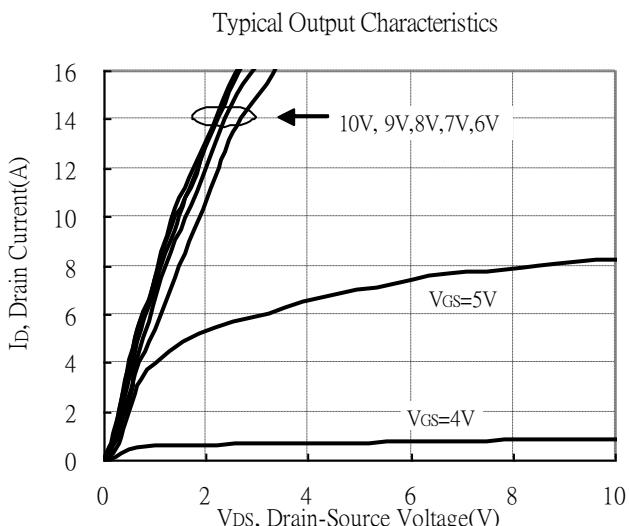
*2.Independent of operating temperature

*3.Pulse width limited by maximum junction temperature.

Recommended soldering footprint

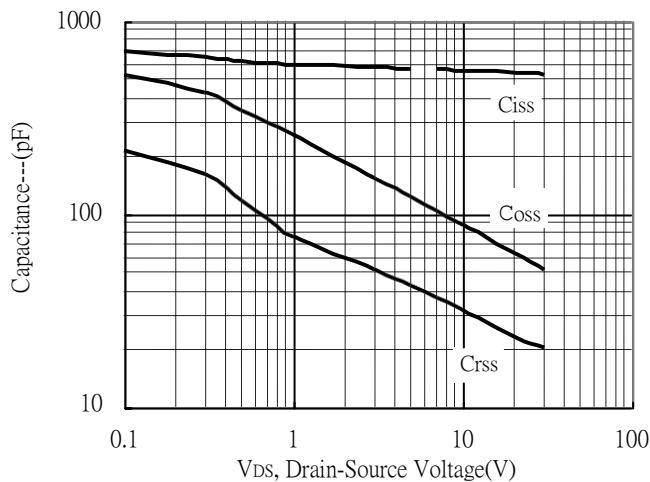


Typical Characteristics

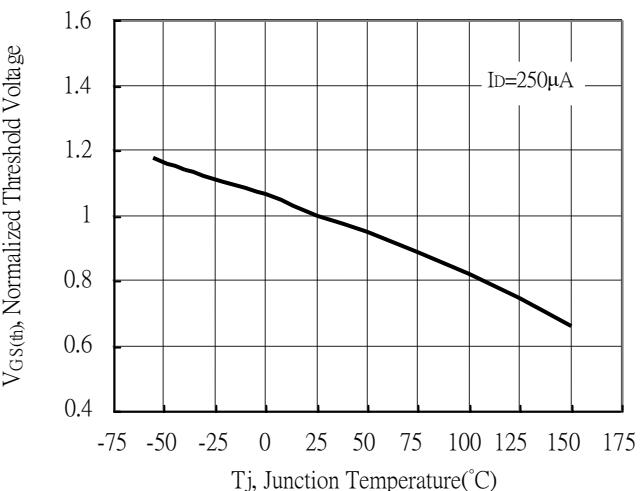


Typical Characteristics(Cont.)

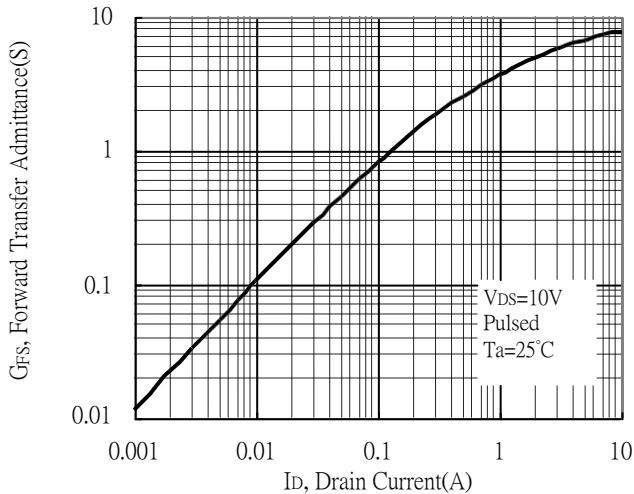
Capacitance vs Drain-to-Source Voltage



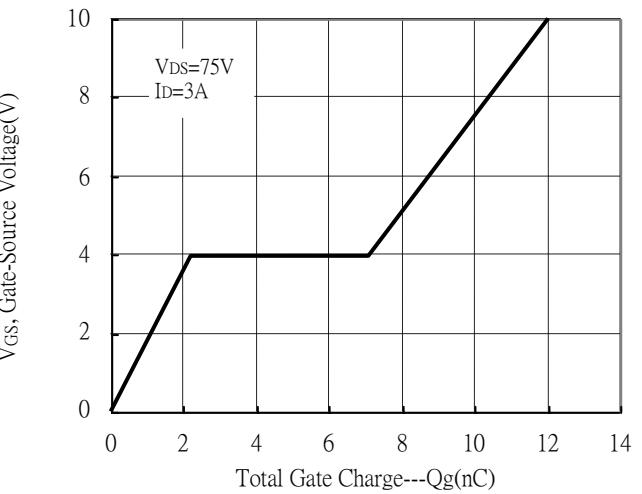
Threshold Voltage vs Junction Temperature



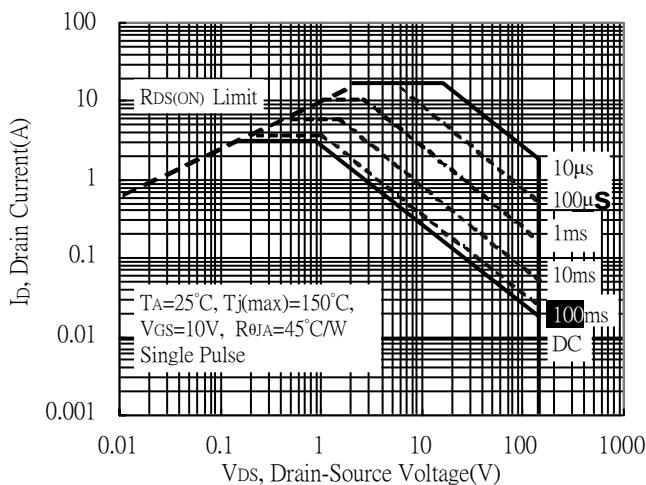
Forward Transfer Admittance vs Drain Current



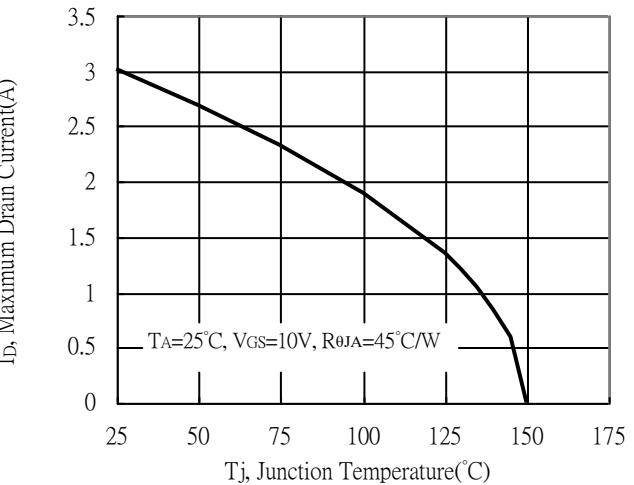
Gate Charge Characteristics



Maximum Safe Operating Area

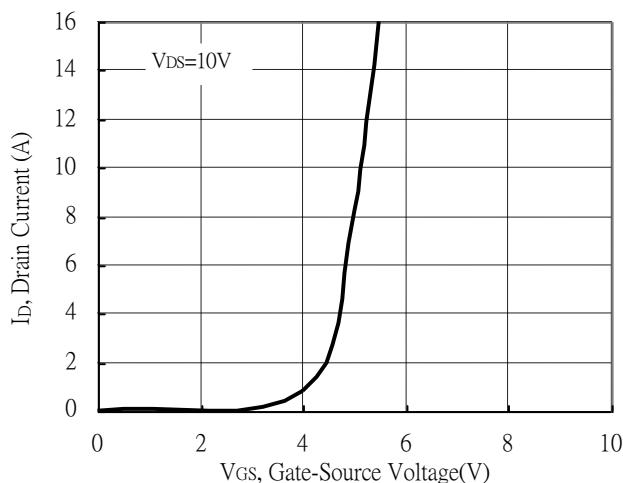


Maximum Drain Current vs Junction Temperature

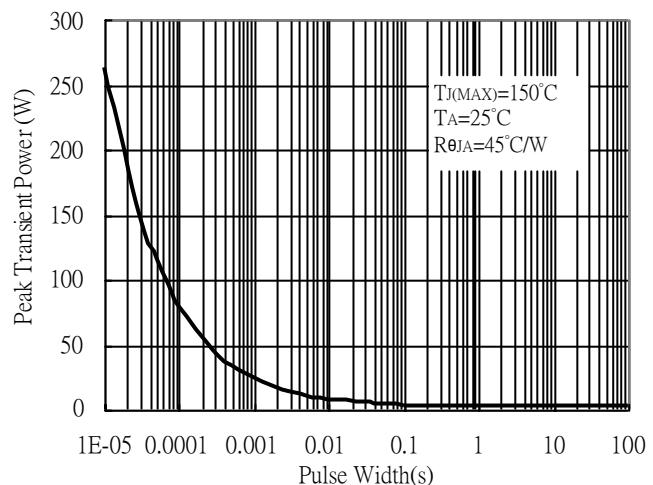


Typical Characteristics(Cont.)

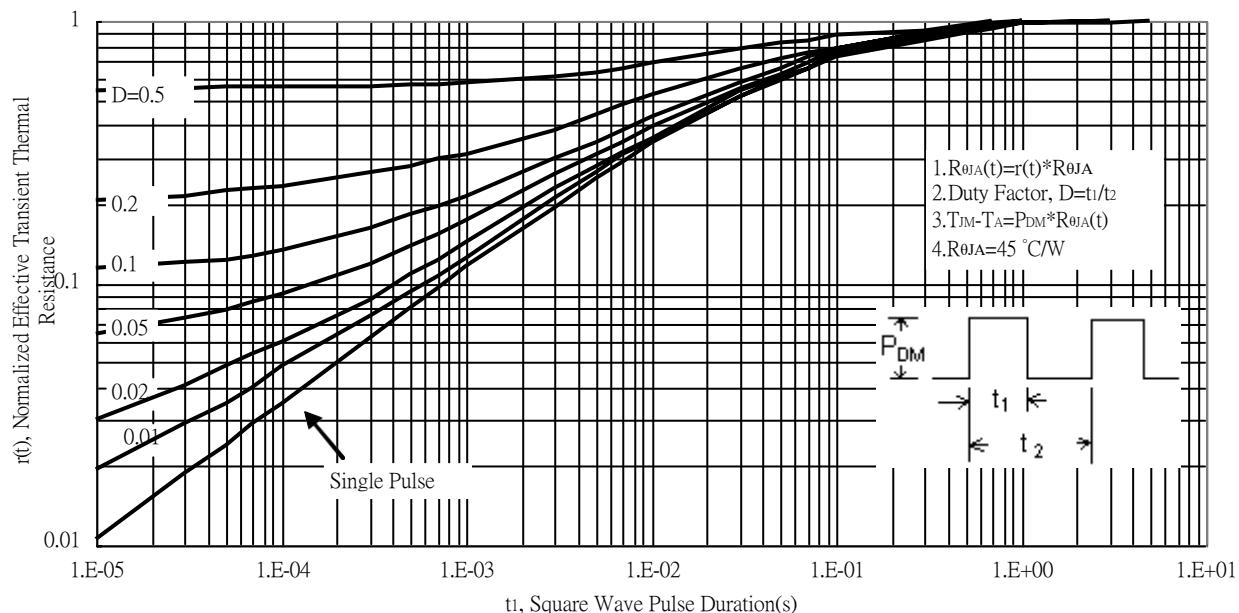
Typical Transfer Characteristics



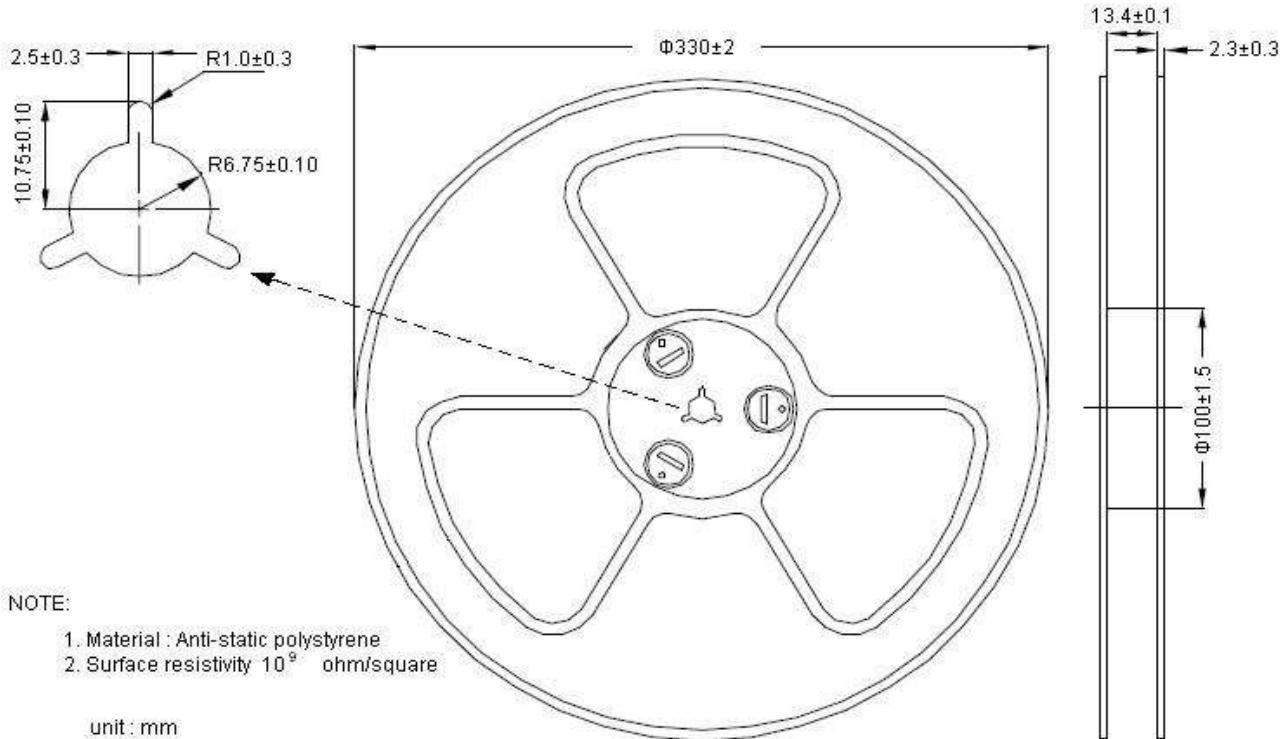
Single Pulse Maximum Power Dissipation



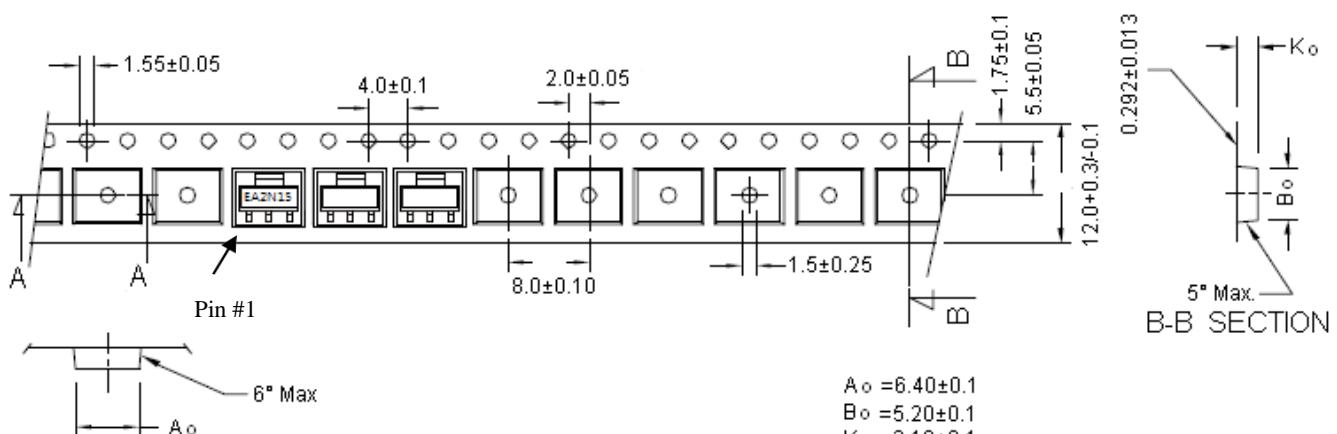
Transient Thermal Response Curves



Reel Dimension

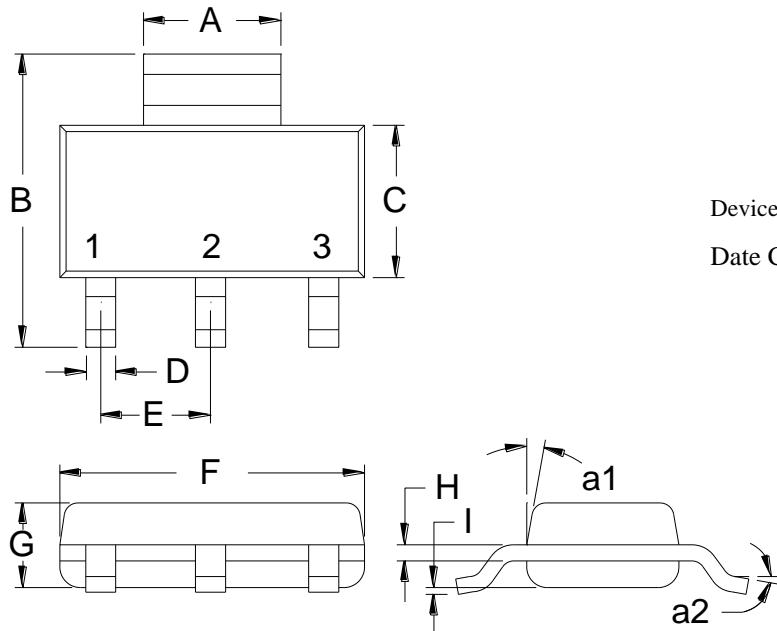


Carrier Tape Dimension

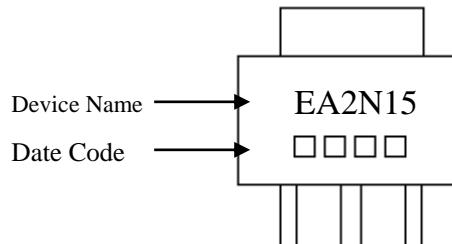


Uni : millimeter

SOT-223 Dimension



Marking:



Style: Pin 1.Gate 2.Drain 3.Source

3-Lead SOT-223 Plastic Surface Mounted Package

Date Code (counting from left to right) :

1st code: year code, the last digit of Christian year

2nd code : month code, Jan→A, Feb→B, Mar→C, Apr→D, May→E, Jun→F, Jul→G, Aug→H, Sep→J, Oct→K, Nov→L, Dec→M

3rd and 4th codes : production serial number, 01~99

*: Typical

DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	0.1142	0.1220	2.90	3.10	G	0.0551	0.0709	1.40	1.80
B	0.2638	0.2874	6.70	7.30	H	0.0098	0.0138	0.23	0.35
C	0.1299	0.1457	3.30	3.70	I	0.0008	0.0039	0.02	0.10
D	0.0236	0.0315	0.60	0.80	a1	*13°	-	*13°	-
E	*0.0906	-	*2.30	-	a2	0 °	10 °	0 °	10 °
F	0.2480	0.2638	6.30	6.70					